

## **KSC5405F**

## **High Voltage Power Switching Applications**



## **NPN Silicon Transistor**

## Absolute Maximum Ratings $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CES</sub>	Collector-Base Voltage	1000	V
V <sub>CEO</sub>	Collector-Emitter Voltage	450	V
V <sub>EBO</sub>	Emitter-Base Voltage	9	V
I <sub>C</sub>	Collector Current (DC)	5	А
I <sub>CP</sub>	Collector Current (Pulse)	10	А
I <sub>B</sub>	Base Current (DC)	2	Α
I <sub>BP</sub>	Base Current (Pulse)	4	А
P <sub>C</sub>	Collector Dissipation ( T <sub>C</sub> =25°C)	40	W
TJ	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 65 ~ 150	°C

## Electrical Characteristics $T_C=25$ °C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V <sub>CEO</sub> (sus)	*Collector-Emitter Sustaining Voltage	$I_C = 100 \text{mA}, I_B = 0$	450			V
I <sub>CES</sub>	Collector Cut-off Current	$V_{CE} = 1000V, V_{BE} = 0$			1	mA
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{BE} = 9V, I_{C} = 0$			10	mA
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> =5V, I <sub>C</sub> =0.6A	10		40	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = 2.5A, I_B = 0.5A$			1.5	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage:	$I_C = 2.5A, I_B = 0.5A$			1.3	V
t <sub>ON</sub>	Turn On Time	$V_{CC} = 250V, I_{C} = 2.5A$			1	μs
t <sub>STG</sub>	Storage Time	$I_{B1} = -I_{B2} = 0.5A$			4	μs
t <sub>F</sub>	Fall Time	$R_L=100\Omega$			0.8	μs

<sup>\*</sup> Pulsed Test: PW = 300uS, duty cycle = 1.5%

# **Typical Characteristics**

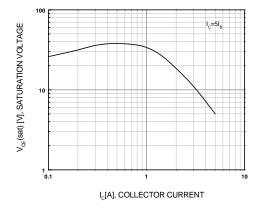


Figure 1. DC current Gain

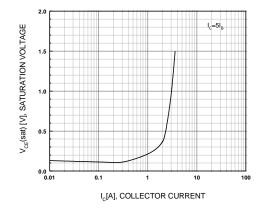


Figure 2. Collector-Emitter Saturation Voltage

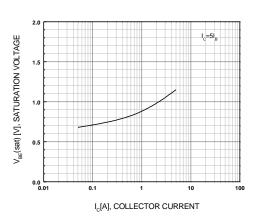


Figure 3. Base-Emitter Saturation Voltage

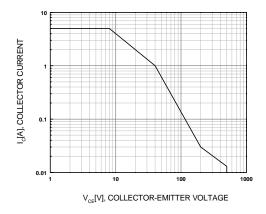


Figure 4. Safe Operating Area

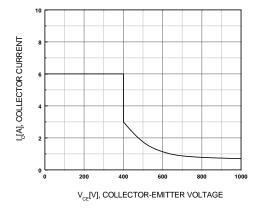


Figure 5. Reverse Bias Safe Operating Area

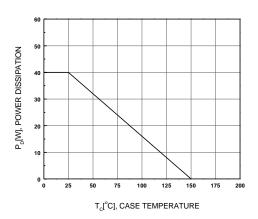
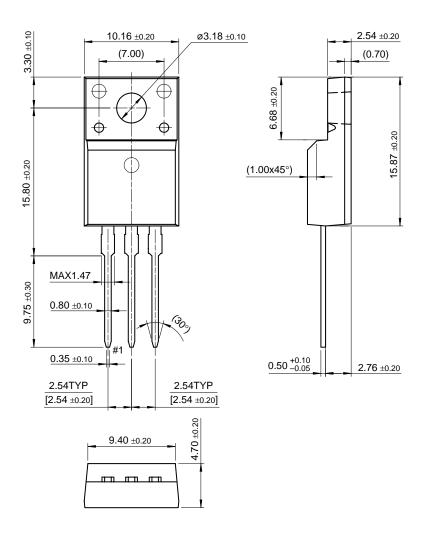


Figure 6. Power Derating

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## **Package Dimensions**

## TO-220F



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E <sup>2</sup> CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	I <sup>2</sup> C <sup>TM</sup>	$OCX^{TM}$	RapidConfigure™	UHC™
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